Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Takashi Usuki	06/12/2006

RECEIVING PARTY DATA

Name:	Sony Corporation	
Street Address:	7-35 Kitashinagawa	
Internal Address:	6-Chome, Shinagawa-Ku	
City:	Toyko	
State/Country:	JAPAN	

Name:	Sony Electronics Inc.	
Street Address:	1 Sony Drive	
City:	Park Ridge	
State/Country:	NEW JERSEY	
Postal Code:	07656	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11457115

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 86631/7114

PATENT

REEL: 018018 FRAME: 0625

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CH \$40,00

NAME OF SUBMITTER:	Kurt M. Eaton
Total Attachments: 2 source=86631Assignment#page1.tif source=86631Assignment#page2.tif	

PATENT REEL: 018018 FRAME: 0626

ASSIGNMENT

WHEREAS, I, as a below named inventor, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in — METHOD AND SYSTEM FOR SEED BASED CLUSTERING OF CATEGORICAL DATA — for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa, 6-Chome, Shinagawa-Ku, Tokyo, Japan and Sony Electronics Inc., a Delaware corporation with offices at 1 Sony Drive, Park Ridge, New Jersey 07656 (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

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Docket No. 86631/7114 [Sony Ref. No. 50V8083.01]

And I hereby authorize and request my attorney erial number and filing date of this application in the serial Number:	v(s) of record in this application to insert the execution datapaces that follow:
This assignment is being executed on the date i	indicated below.
Chiranjit Acharya	Witness:
ated:	Witness:
Tsunayuki Ohwa	Witness:
ted:	Witness:
Mark Plutowski	Witness:
tod:	Witness:
Takashi Usuki	_ Witness: Mikako Chmatoi
ed: Jane 12, 2006	Witness: Talenga Mishimura
Daga	2 of 2

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PATENT REEL: 018018 FRAME: 0628